

Single 4 x 1 and Dual 2 x 1 Multiplexers

DESCRIPTION

The DG9414, a single 4 to 1 multiplexer, and the DG9415, a dual 2 x 1 multiplexer, are monolithic CMOS analog devices designed for high performance low voltage operation. Combining low power, high speed, low on-resistance and small physical size, the DG9414 and DG9415 are ideal for portable and battery powered applications requiring high performance and efficient use of board space.

Both the DG9414 and DG9415 are built on Vishay Siliconix's low voltage BCD-15 process. Minimum ESD protection, per Method 3015.7, is 2000 V. An epitaxial layer prevents latchup. Break-before-make is guaranteed for DG9415.

FEATURES

- Low voltage operation (+ 2.7 V to + 12 V)
- Low on-resistance - $R_{DS(on)}$: 14 Ω
- Low power consumption
- TTL compatible
- ESD protection > 2000 V (method 3015.7)
- Available in TSSOP-10 (aka MSOP-10)
- **Compliant to RoHS Directive 2002/95/EC**


RoHS
COMPLIANT

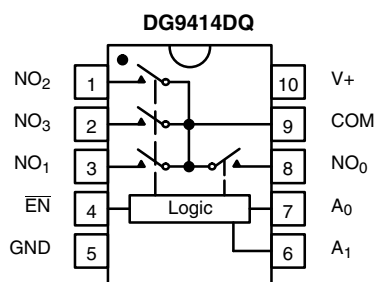
BENEFITS

- High accuracy
- Simple logic interface
- Reduce board space

APPLICATIONS

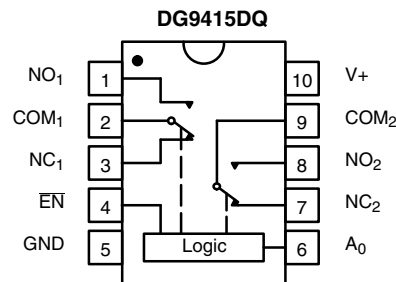
- Battery operated systems
- Portable test equipment
- Sample and hold circuits
- Cellular phones
- Communication systems
- Networking equipment

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



$\overline{EN}$	A_1	A_0	On Switch
1	X	X	None
0	0	0	NO_0
0	0	1	NO_1
0	1	0	NO_2
0	1	1	NO_3

X = Do not care



$\overline{EN}$	A_0	On Switch
1	X	None
0	0	NC_1 NC_2
0	1	NO_1 NO_2

X = Do not care

ORDERING INFORMATION

Temp Range	Package	Part Number
- 40 °C to 85 °C	MSOP-10	DG9414DQ-T1-E3
		DG9415DQ-T1-E3

ABSOLUTE MAXIMUM RATINGS

Parameter	Limit	Unit
Reference V+ to GND	- 0.3 to + 13	V
IN, COM, NC, NO ^a	- 0.3 to (V+ + 0.3)	
Continuous Current (Any terminal)	± 20	mA
Peak Current (Pulsed at 1 ms, 10 % duty cycle)	± 40	
ESD (Method 3015.7)	> 2000	V
Storage Temperature (D Suffix)	- 65 to 150	°C

Notes:

a. Signals on S_X, D_X or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads soldered or welded to PC board.

SPECIFICATIONS (V+ = 3 V)

Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 3 V, ± 10 %, V _{IN} = 0.4 V or 2.4 V ^e		Temp. ^a	Limits - 40 °C to 85 °C			Unit
					Min. ^c	Typ. ^b	Max. ^c	
Analog Switch								
Analog Signal Range ^d	V _{ANALOG}			Full	0		V+	V
On-Resistance	R _{ON}	V+ = 2.7 V, V _{COM} = 1 V/1.5 V/2 V I _{NO} or I _{NC} = 5 mA		Room Full		63	97 101	Ω
R _{ON} Match ^d	ΔR _{ON}			Room		3	11	
R _{ON} Flatness ^{d,f}	R _{ON} Flatness			Room		14	33	
NO or NC Off Leakage Current ^g	I _{NO/NC(off)}	V+ = 3.3 , V _{NO} or V _{NC} = 0.3 V/3 V V _{COM} = 3 V/0.3 V		Room Full	- 1 - 10		1 10	nA
COM Off Leakage Current ^g	I _{COM(off)}			Room Full	- 1 - 10		1 10	
Channel-On Leakage Current ^g	I _{COM(on)}	V+ = 3.3 V V _{COM} = V _{NO} or V _{NC} = 0.3 V/3 V		Room Full	- 1 - 10		1 10	
Digital Control								
Input Current ^g	I _{INL} or I _{INH}	V _{IN} = 0 or V+		Full	- 1		1	μA
Input High Voltage ^d	V _{INH}			Full	1.6			V
Input Low Voltage ^d	V _{INL}			Full			0.4	
Dynamic Characteristics								
Turn-On Time	t _{ON}	V _{NO} or V _{NC} = 1.5 V		Room Full		102	125 142	ns
Turn-Off Time	t _{OFF}			Room Full		45	68 75	
Break-Before-Make Time	t _D			Room	7	78		
Transition Time	t _{trans}	V _{NO} = 1.5 V/0 V, V _{NC} = 0 V/1.5 V		Room Full		81	128 144	
Charge Injection ^d	Q _{INJ}	C _L = 1 nF, V _{gen} = 0 V, R _{gen} = 0 Ω		Room		3		pC
Off-Isolation	OIRR	R _L = 50 Ω, C _L = 5 pF, f = 1 MHz		Room		- 58		dB
Channel-to-Channel Crosstalk (DG9415)	X _{TALK}	R _L = 50 Ω, f = 1 MHz		Room		- 64		
NO, NC Off Capacitance	C _{NO(off)} , C _{NC(off)}	f = 1 MHz	DG9414	Room		11		pF
			DG9415	Room		10		
COM Off Capacitance	C _{COM(off)}		DG9414	Room		26		
			DG9415	Room		13		
COM On Capacitance	C _{COM(on)}		DG9414	Room		43		
			DG9415	Room		25		
Power Supply								
Power Supply Range	V+				2.7		3.3	V
Power Supply Current ^h	I+	V+ = 3.3 V, V _{IN} = 0 V or 3.3 V		Full			1	μA



SPECIFICATIONS (V+ = 5 V)								
Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 5 V, ± 10 %, VIN = 0.8 V or 2.4 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit	
				Min. ^c	Typ. ^b	Max. ^c		
Analog Switch								
Analog Signal Range ^d	VANALOG		Full	0		V+	V	
On-Resistance	RON	V+ = 4.5 V, VCOM = 1.5 V/2.5 V/3.5 V INO or INC = 10 mA	Room Full		33	56 60	Ω	
RON Match	ΔRON		Room		2	10		
RON Flatness ^f	RON Flatness		Room		10	20		
NO or NC Off Leakage Current ^g	INO/NC(off)	V+ = 5.5 V, VNO or VNC = 1 V/4.5 V VCOM = 4.5 V/1 V	Room Full	- 1 - 10		1 10	nA	
COM Off Leakage Current ^g	ICOM(off)		Room Full	- 1 - 10		1 10		
Channel-On Leakage Current ^g	ICOM(on)	V+ = 5.5 V VCOM = VNO or VNC = 1 V/4.5 V	Room Full	- 1 - 10		1 10		
Digital Control								
Input Current ^h	INL or INH	VIN = 0 or V+	Full	- 1		1	μA	
Input High Voltage ^d	VINH		Full	1.8			V	
Input Low Voltage ^d	VINL		Full			0.6		
Dynamic Characteristics								
Turn-On Time ^h	tON	VNO or VNC = 3 V	Room Full		56	77 86	ns	
Turn-Off Time ^h	tOFF		Room Full		25	46 50		
Break-Before-Make Timet ^h	tD		Room	7	34			
Transition Time	ttrans	VNO = 3 V/ 0 V, VNC = 0 V/3 V	Room Full		47	77 84	dB	
Off-Isolation	OIRR	RL = 50 Ω, CL = 5 pF, f = 1 MHz	Room		- 58			
Channel-to-Channel Crosstalk (DG9415)	XTALK	RL = 50 Ω, f = 1 MHz	Room		- 64			
Charge Injection ^d	QINJ	CL = 1 nF, Vgen = 0 V, Rgen = 0 Ω	Room		6		pC	
NO, NC Off Capacitance	CNO(off), CNC(off)	f = 1 MHz	DG9414	Room		11		pF
			DG9415	Room		10		
COM Off Capacitance	CCOM(off)		DG9414	Room		25		
			DG9415	Room		13		
COM On Capacitance	CCOM(on)		DG9414	Room		42		
			DG9415	Room		24		
Power Supply								
Power Supply Range	V+			4.5		5.5	V	
Power Supply Current ^h	I+	V+ = 5.5 V, VIN = 0 V or 5.5 V	Full			1	μA	

Notes:

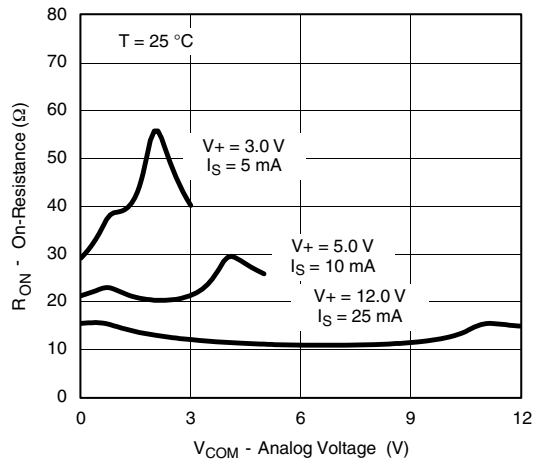
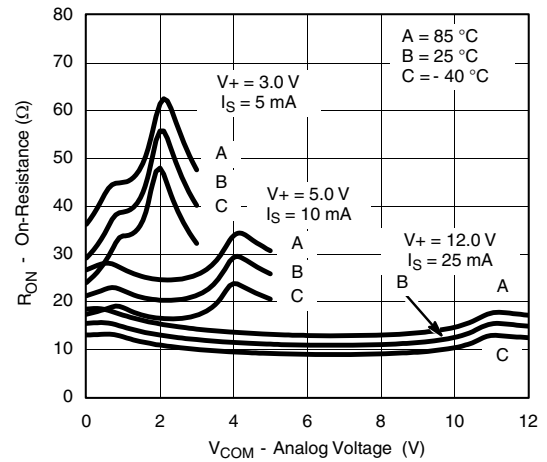
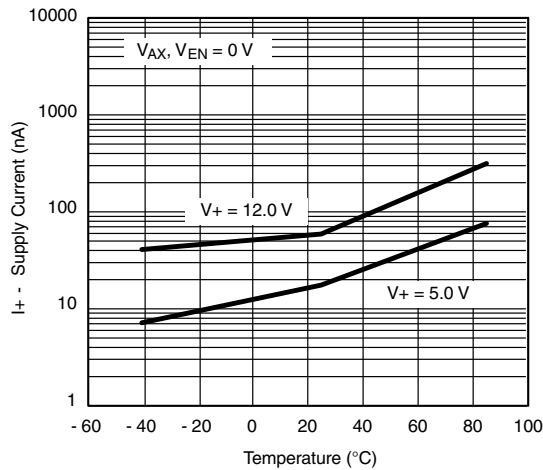
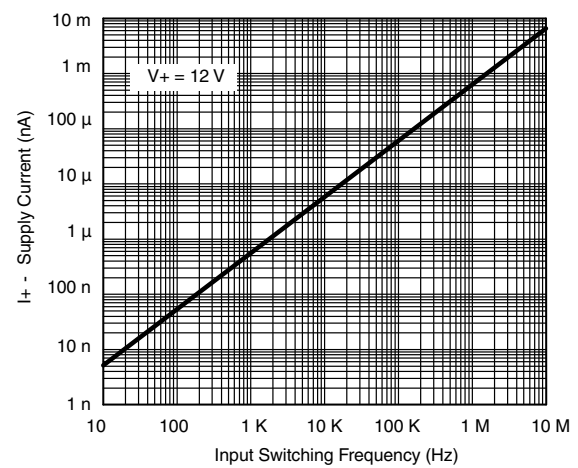
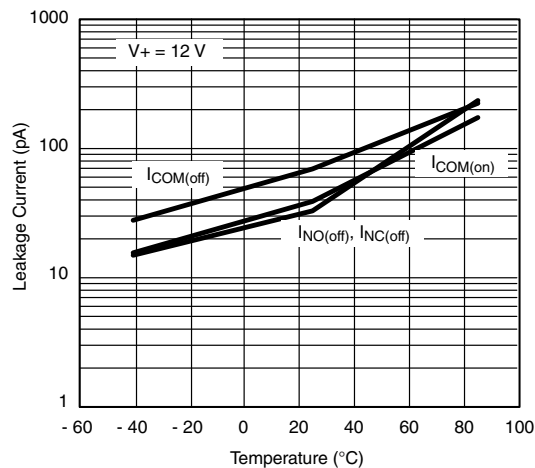
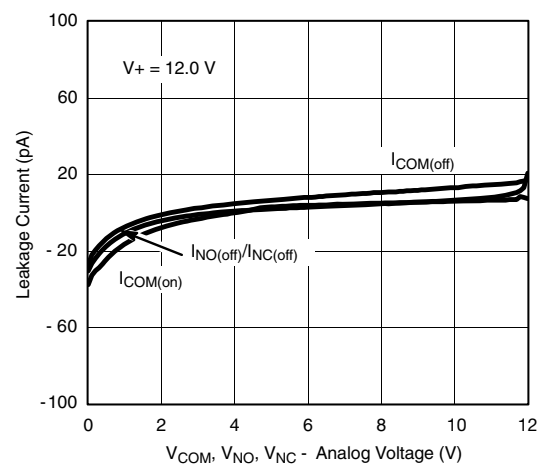
- Room = 25 °C, Full = as determined by the operating suffix.
- Typical values are for design aid only, not guaranteed nor subject to production testing.
- The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
- Guarantee by design, nor subjected to production test.
- V_{IN} = input voltage to perform proper function.
- Difference of min and max values.
- Guaranteed by 12 V leakage testing, not production tested.
- Guaranteed by worst case test conditions and not subject to test.

SPECIFICATIONS (V+ = 12 V)								
Parameter	Symbol	Test Conditions Unless Specified V+ = 12 V, VIN = 0.8 V or 2.4 V ^e		Temp. ^a	Limits - 40 °C to 85 °C			Unit
					Min. ^c	Typ. ^b	Max. ^c	
Analog Switch								
Analog Signal Range ^d	VANALOG			Full	0		12	V
RON Match	ΔRON			Room		1	9	Ω
RON Flatness ^{d,f}	RON Flatness			Room		1	10	
On-Resistance	RON	V+ = 10.8 V, INO, INC = 25 mA VCOM = 2/9 V		Room Full		14	17 19	
Switch Off Leakage Current	INO(off) INC(off)	VCOM = 1/11 V VNO, VNC = 11/1 V		Room Full	- 1 - 10		1 10	nA
	ICOM(off)			Room Full	- 1 - 10		1 10	
Channel On Leakage Current	ICOM(on)	VNO, VNC = VCOM = 11/1 V		Room Full	- 1 - 10		1 10	
Digital Control								
Input Current	IINL or IINH	VIN = 0 or V+		Full	- 1		1	μA
Input High Voltage ^d	VINH			Full	2.4			V
Input Low Voltage ^d	VINL			Full			0.8	
Dynamic Characteristics								
Turn-On Time ^h	tON	RL = 300 Ω, CL = 35 pF VNO, VNC = 5 V See Figure 2		Room Full		33	55 59	ns
Turn-Off Time ^h	tOFF			Room Full		17	40 41	
Break-Before-Make Time Delay ^h	tD	DG419L Only, VNC, VNO = 5 V RL = 300 Ω, CL = 35 pF		Room	2	24		
Transition Time	ttrans	VNO = 5 V/ 0 V, VNC = 0 V/ 5 V		Room Full		29	56 59	
Charge Injection ^d	QINJ	Vg = 0 V, Rg = 0 Ω, CL = 1 nF		Room		13		pC
Off Isolation ^d	OIRR	RL = 50 Ω, CL = 5 pF f = 1 MHz		Room		- 58		dB
Channel-to-Channel Crosstalk ^d	XTALK			Room		- 64		
NO, NC Off Capacitance ^d	CNO(off), CNC(off)	VIN = 0 or V+, f = 1 MHz		DG9414	Room		10	pF
				DG9415	Room		10	
COM Off Capacitance	CCOM(off)			DG9414	Room		24	
				DG9415	Room		13	
COM On Capacitance ^d	CCOM(on)			DG9414	Room		40	
				DG9415	Room		23	
Power Supplies								
Positive Supply Current	I+	VIN = 0 V or 12 V		Full			1	μA

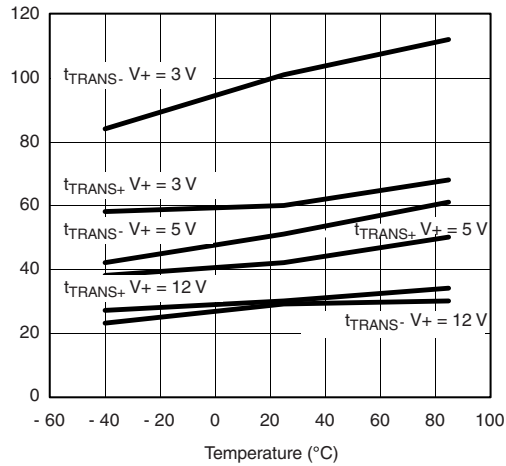
Notes:

- a. Room = 25 °C, Full = as determined by the operating suffix.
b. Typical values are for design aid only, not guaranteed nor subject to production testing.
c. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
d. Guarantee by design, nor subjected to production test.
e. V_{IN} = input voltage to perform proper function.
f. Difference of min and max values.
g. Guaranteed by 12 V leakage testing, not production tested.
h. Guaranteed by worst case test conditions and not subject to test.

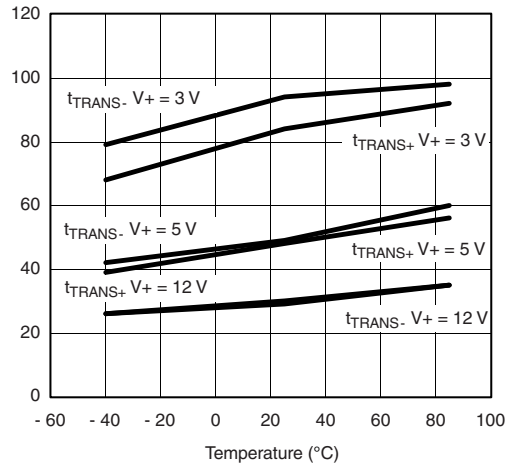
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 R_{ON} vs. V_{COM} and Supply Voltage

 R_{ON} vs. Analog Voltage and Temperature

Supply Current vs. Temperature

Supply Current vs. Input Switching Frequency

Leakage Current vs. Temperature

Leakage vs. Analog Voltage

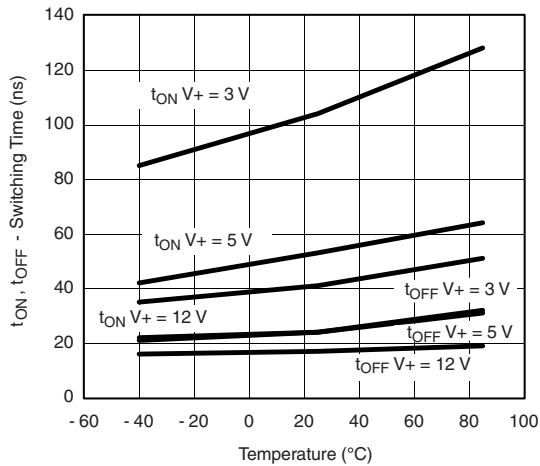
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



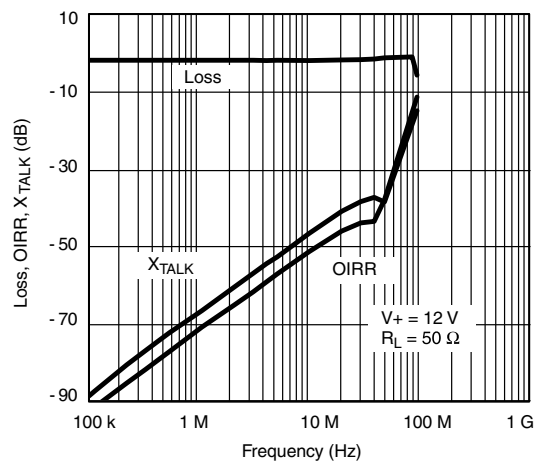
Transistion Time vs. Temperature (DG9414)



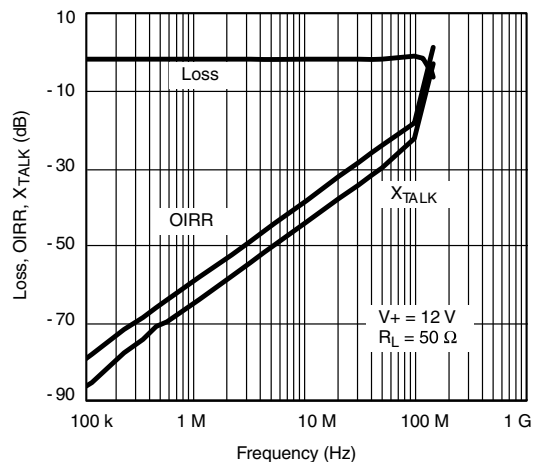
Transistion Time vs. Temperature (DG9415)



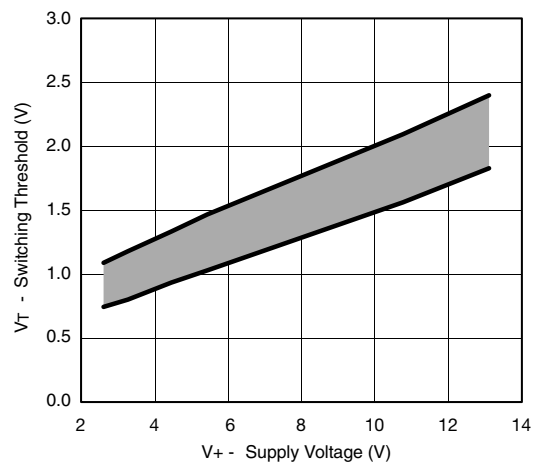
Switching Time vs. Temperature



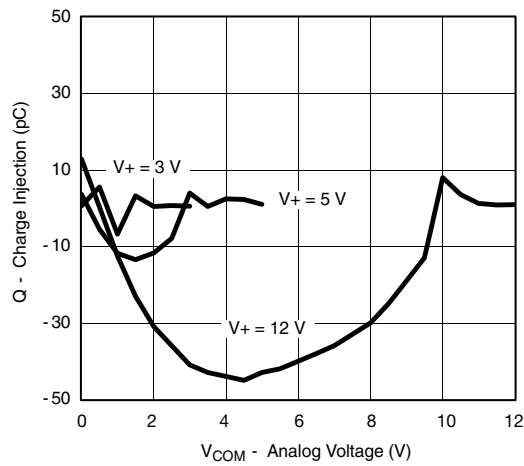
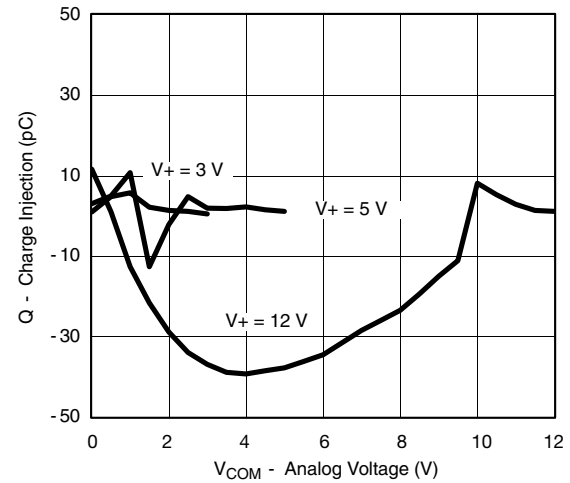
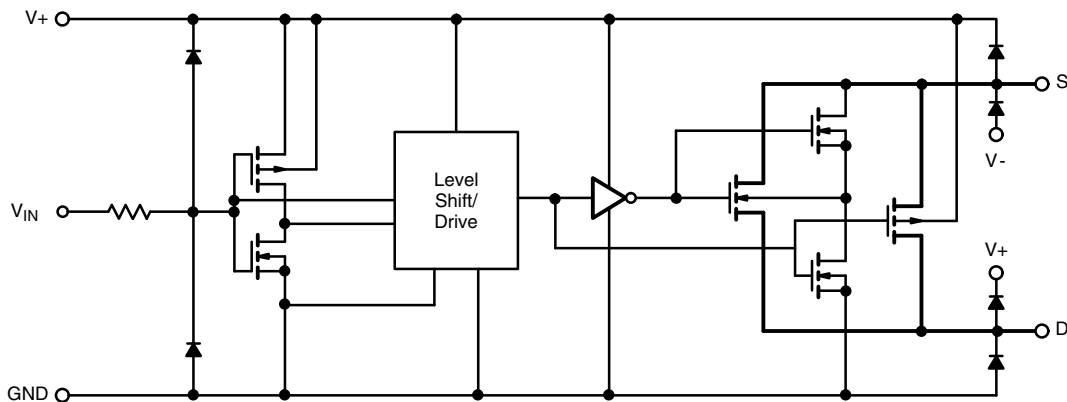
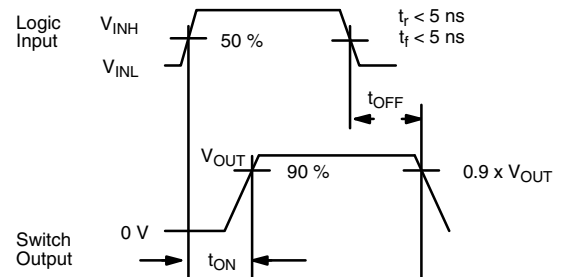
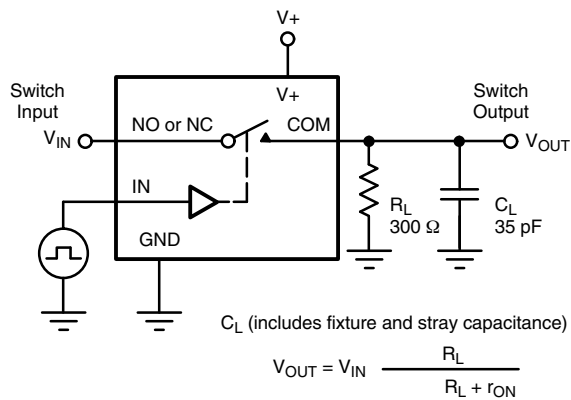
Insertion Loss, Off-Isolation Crosstalk vs. Frequency (DG9414)



Insertion Loss, Off-Isolation Crosstalk vs. Frequency (DG9415)



Switching Threshold vs. Supply Voltage

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Charge Injection vs. Analog Voltage (DG9414)

Charge Injection vs. Analog Voltage (DG9415)
SCHEMATIC DIAGRAM (Typical Channel)

Figure 1.
TEST CIRCUITS


Note: Logic input waveform is inverted for switches that have the opposite logic sense control

Figure 2. Switching Time

TEST CIRCUITS

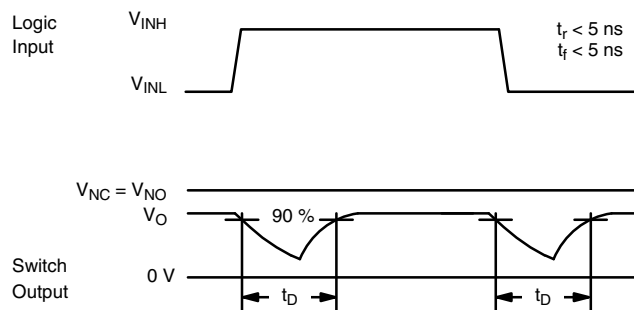
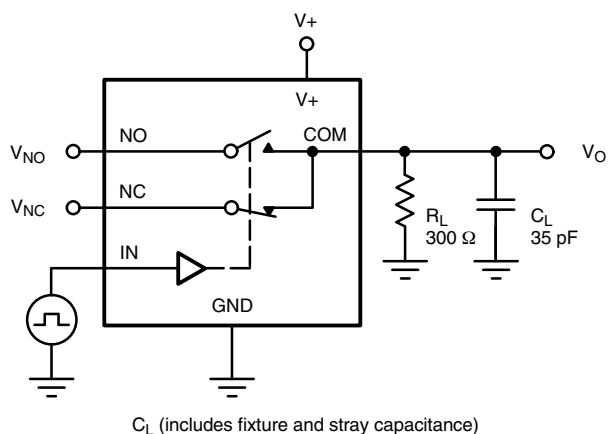


Figure 3. Break-Before-Make

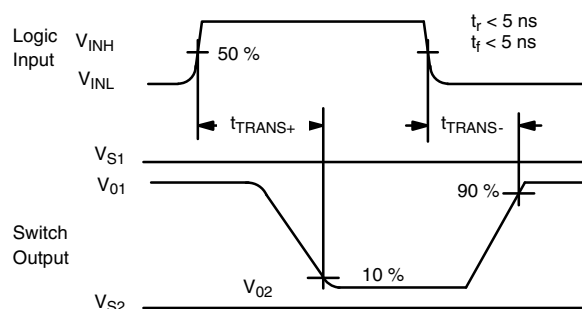
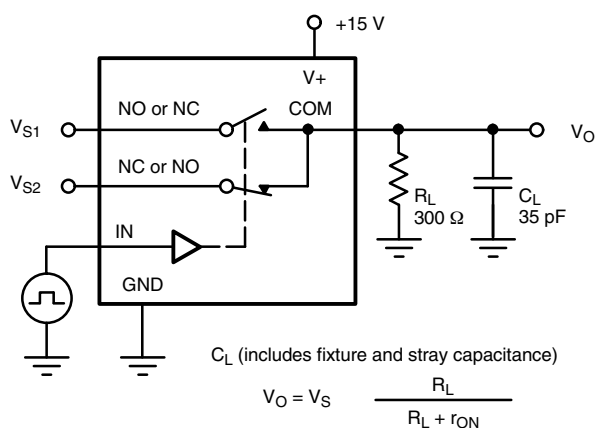
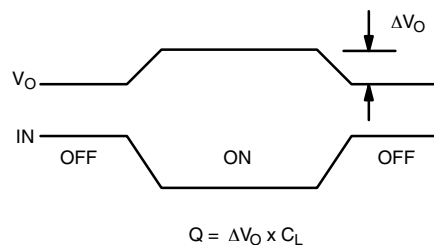
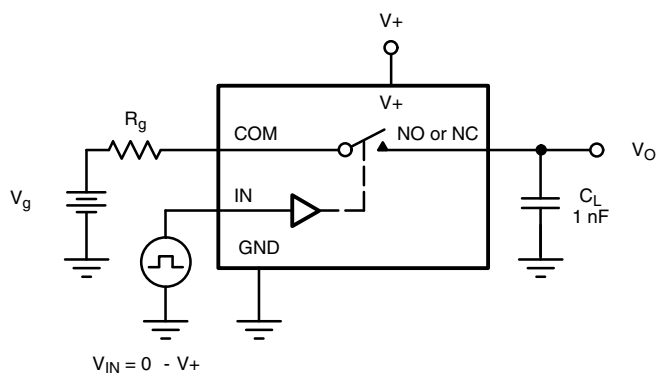
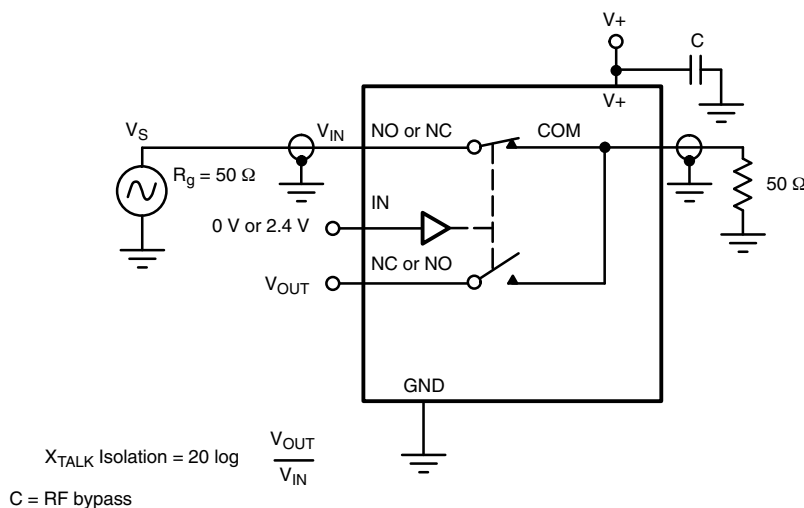
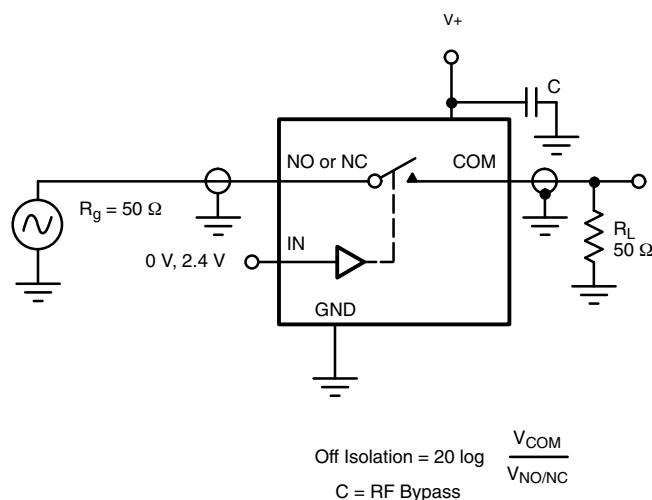
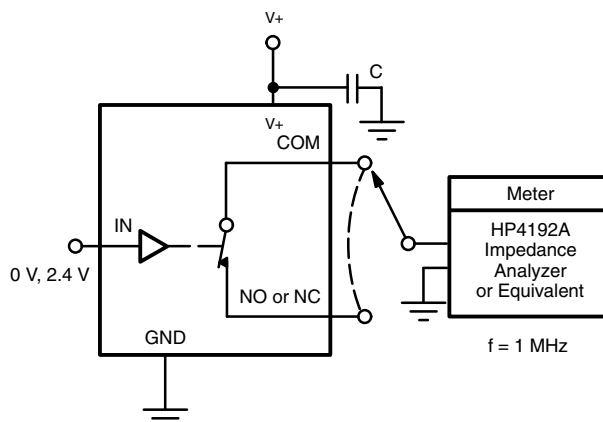


Figure 4. Transition Time



IN dependent on switch configuration Input polarity determined by sense of switch.

Figure 5. Charge Injection

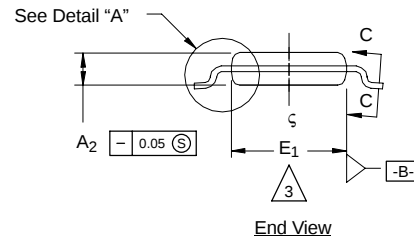
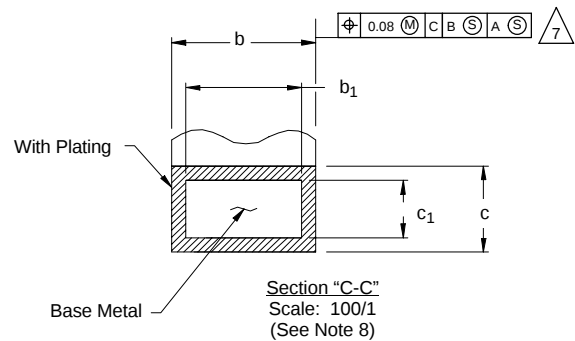
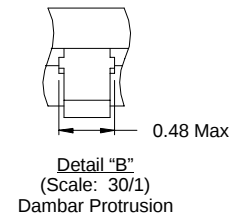
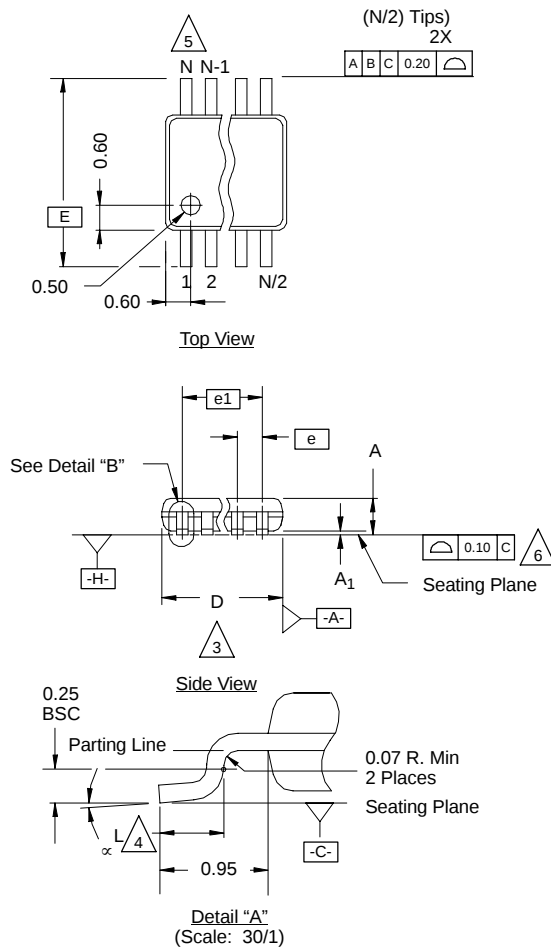
TEST CIRCUITS

Figure 6. Crosstalk

Figure 7. Off Isolation

Figure 8. Source/Drain Capacitances

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71766.



MSOP: 10-LEADS

JEDEC Part Number: MO-187, (Variation AA and BA)



NOTES:

- Die thickness allowable is 0.203 ± 0.0127 .
- Dimensioning and tolerances per ANSI.Y14.5M-1994.
- Dimensions "D" and "E₁" do not include mold flash or protrusions, and are measured at Datum plane $\square H$, mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimension is the length of terminal for soldering to a substrate.
- Terminal positions are shown for reference only.
- Formed leads shall be planar with respect to one another within 0.10 mm at seating plane.
- The lead width dimension does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the lead width dimension at maximum material condition. Dambar cannot be located on the lower radius or the lead foot. Minimum space between protrusions and an adjacent lead to be 0.14 mm. See detail "B" and Section "C-C".
- Section "C-C" to be determined at 0.10 mm to 0.25 mm from the lead tip.
- Controlling dimension: millimeters.
- This part is compliant with JEDEC registration MO-187, variation AA and BA.
- Datums $\square A$ and $\square B$ to be determined Datum plane $\square H$.
- Exposed pad area in bottom side is the same as the leadframe pad size.

N = 10L

Dim	MILLIMETERS			Note
	Min	Nom	Max	
A	-	-	1.10	
A ₁	0.05	0.10	0.15	
A ₂	0.75	0.85	0.95	
b	0.17	-	0.27	8
b ₁	0.17	0.20	0.23	8
c	0.13	-	0.23	
c ₁	0.13	0.15	0.18	
D	3.00 BSC			3
E	4.90 BSC			
E ₁	2.90	3.00	3.10	3
e	0.50 BSC			
e ₁	2.00 BSC			
L	0.40	0.55	0.70	4
N	10			5
α	0°	4°	6°	

ECN: T-02080—Rev. C, 15-Jul-02
DWG: 5867



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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.